December 2012

FST3345 — 8-Bit Bus Switch

Features

- 4 Ω Switch Connection between Two Ports
- Minimal Propagation Delay through the Switch
- Low I_{CC}
- Zero Bounce in Flow-through Mode
- Control Inputs Compatible with TTL Level

Description

The FST3345 switch provides eight-bits of high-speed CMOS TTL-compatible bus switching. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

The device is organized as an eight-bit switch with dual output enable inputs (OE and /OE). When /OE is LOW or OE is HIGH, the switch is ON and port A is connected to port B. When /OE is HIGH, and OE is LOW, the switch is OPEN and a high-impedance state exists between the two ports.

Ordering Information

Part Number	Operating Temperatur e Range	Package	Packing Method
FST3345MTCX	-40 to +85°C	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4 mm Wide	Tape and Reel

Logic Diagram

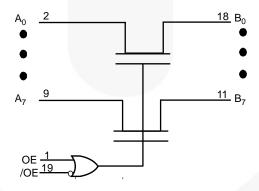


Figure 1. Logic Diagram

Pin Configuration

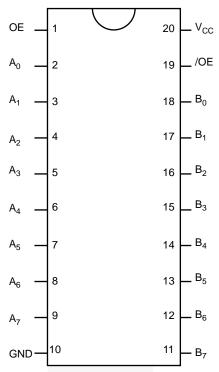


Figure 2. Pin Configuration

Pin Descriptions

Pin #	Pin Names	Description
1,19	OE, /OE	Bus Switch Enables
2,3,4,5,6,7,8,9	$A_0, A_1, A_2, A_3, A_4, A_5, A_6, A_7$	Bus A
10	GND	Ground
11,12,13,14,15,16,17,18	B ₇ ,B ₆ ,B ₅ ,B ₄ ,B ₃ ,B ₂ ,B ₁ ,B ₀	Bus B
20	V _{cc}	Supply Voltage

Truth Table

1	nput	Function
OE	/OE	Function
Don't Care	LOW	Connect
HIGH	Don't Care	Connect
LOW	HIGH	Disconnect

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	7.0	V
Vs	DC Switch Voltage	-0.5	7.0	V
V _{IN}	DC Input Voltage ⁽¹⁾	-0.5	7.0	V
I _{IK}	DC Input Diode Current, V _{IN} < 0 V		-50	mA
I _{OUT}	DC Output Sink Current		128	mA
I _{CC} / I _{GND}	DC V _{CC} / GND Current		±100	mA
T _{STG}	Storage Temperature Range	-65	+150	°C

Note:

 The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parar	Min.	Max.	Unit	
V _{CC}	Power Supply Operating		4.0	5.5	V
V_{IN}	Input Voltage		0	5.5	V
V _{OUT}	Output Voltage		0	5.5	V
4 4	Switch Control Input ⁽²⁾	0	5	no/\/	
t _r , t _f	Input Rise and Fall Time Switch I/O		0	DC	ns/V
T _A	Operating Temperature, Fr	-40	+85	°C	

Note:

2. Unused control inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Typical values are at $V_{CC} = 5.0 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

Cumple of	Doromotor	Conditions	V _{cc} (V)	T _A =-40 to +85°C			l Inito
Symbol	Parameter	Conditions V _{cc}		Min.	Тур.	Max.	Units
V_{IK}	Clamp Diode Voltage	I _{IN} = -18 mA	4.5			-1.2	V
V_{IH}	High-Level Input Voltage		4.0 to 5.5	2.0			V
V_{IL}	Low-Level Input Voltage		4.0 to 5.5			0.8	V
I _{IN}	Input Leakage Current	$0 \le V_{IN} \le 5.5 \text{ V}$	5.5			±1.0	μA
I _{OZ}	Off-state Leakage Current	$0 \le A, B \le V_{CC}$	5.5			±1.0	μA
		$V_{IN} = 0 \text{ V}, I_{IN} = 64 \text{ mA}$	4.5		4	7	
R _{ON}	Switch On Resistance ⁽³⁾	$V_{IN} = 0 \text{ V}, I_{IN} = 30 \text{ mA}$	4.5		4	7	Ω
IVON	Switch On Resistance	$V_{IN} = 2.4 \text{ V}, I_{IN} = 15 \text{ mA}$	4.5		8	15	32
		$V_{IN} = 2.4 \text{ V}, I_{IN} = 15 \text{ mA}$	4.0		11	20	
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	5.5			3	μA
Δl _{CC}	Increase in I _{CC} per Input	One Input at 3.4 V, Other Inputs at V _{CC} or GND	5.5			2.5	mA

Note:

3. Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the A or B pins.

AC Electrical Characteristics

 $T_A = -40 \text{ to } +85^{\circ}\text{C}, \ C_L = 50 \text{ pF}, \ \text{and} \ R_U = R_D = 500 \ \Omega.$

Symbol	Parameter	Conditions	$V_{CC} = 4.5$	– 5.5 V	V _{cc} =	4.0 V	Units	Figure
Symbol	Parameter	Conditions	Min.	Max.	Min.	Max.	Units	rigure
t _{PHL} , t _{PLH}	Propagation Delay Bus-to-Bus ⁽⁴⁾	V _{IN} = Open		0.25		0.25	ns	Figure 3 Figure 4
t _{PZH} ,t _{PZL}	Output Enable Time	$V_{IN} = 7 \text{ V for } t_{PZL}$ $V_{IN} = \text{Open for } t_{PZH}$	1.5	6.5		7.0	ns	Figure 3 Figure 4
t _{PHZ} , t _{PLZ}	Output Disable Time	$V_{IN} = 7 \text{ V for } t_{PLZ}$ $V_{IN} = \text{Open for } t_{PHZ}$	1.0	8.0		8.2	ns	Figure 3 Figure 4

Note:

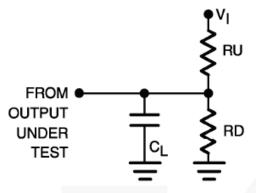
4. This parameter is guaranteed by design, but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical on resistance of the switch and the 50 pF load capacitance when driven by an ideal voltage source (zero output impedance).

Capacitance

 $T_A = +25$ °C, f = 1 MHz. Capacitance is characterized, but not tested.

Symbol	Parameter Conditions		Тур.	Units
C _{IN}	Control Pin Input Capacitance	V _{CC} = 5.0 V	4	pF
C _{I/O}	Input/Output Capacitance	V _{CC} , /OE = 5.0 V, OE = 0 V	5	pF

AC Loadings and Waveforms



Notes: Input driven by 50 Ω source terminated in 50 Ω . C_L includes load and stray capacitance. Input PRR = 1.0 MHz, t_w = 500 ns.

Figure 3. AC Test Circuit

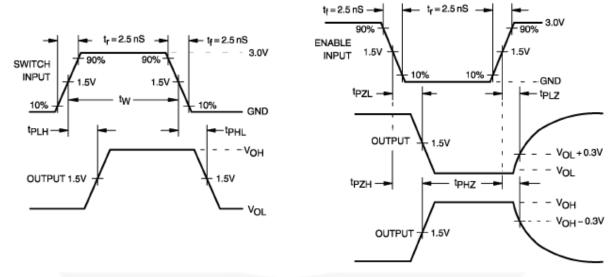
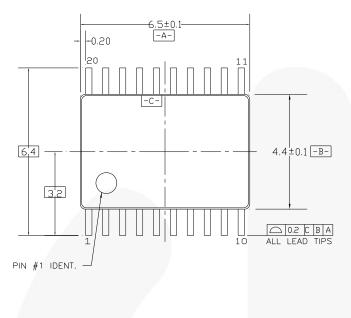
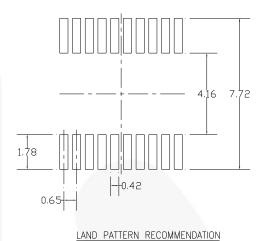
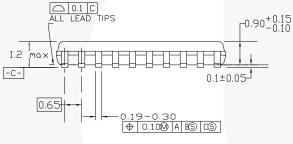


Figure 4. AC Waveforms

Physical Dimensions



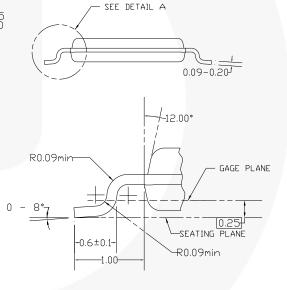




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NOTES:

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- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.



DETAIL A

MTC20REVD1

Figure 5. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4 mm Wide

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